

Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-12	V
Collector-Emitter Voltage	V_{CEO}	-12	V
Emitter-Base Voltage	V_{EBO}	-5	V
Collector Current - Continuous	I_C	-2	A
Peak Pulse Collector Current	I_{CM}	-3	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3) @ $T_A = 25^\circ\text{C}$	P_D	450	mW
Thermal Resistance, Junction to Ambient (Note 3) @ $T_A = 25^\circ\text{C}$	$R_{\theta JA}$	275	$^\circ\text{C/W}$
Power Dissipation (Note 4) @ $T_A = 25^\circ\text{C}$	P_D	650	mW
Thermal Resistance, Junction to Ambient (Note 3) @ $T_A = 25^\circ\text{C}$	$R_{\theta JA}$	192	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

Notes: 3. Device mounted on FR-4 PCB, with minimum recommended pad layout.
 4. Device mounted on FR-4 PCB, mounted on 25mmx25mm square pad 1oz coverage of copper

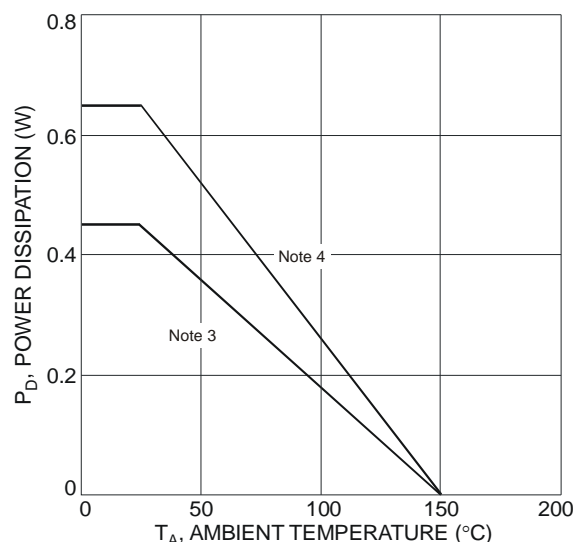


Fig. 1 Power Dissipation vs. Ambient Temperature

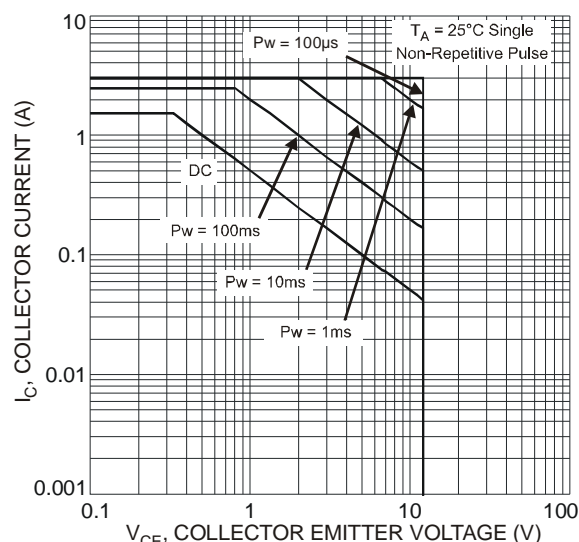


Fig. 2 Safe Operating Area

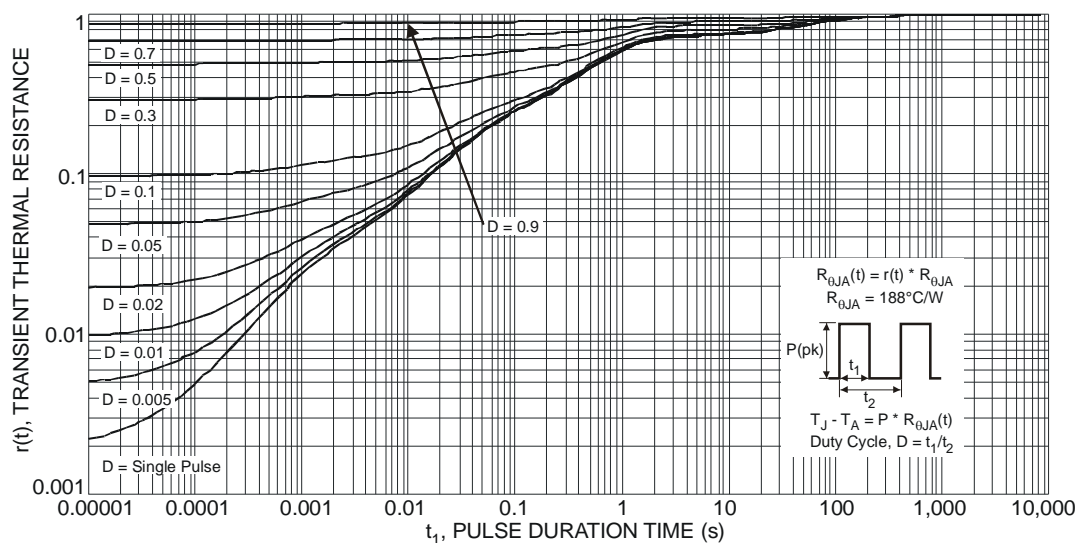


Fig. 3 Transient Thermal Response

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV _{CBO}	-12	-35	—	V	I _C = -100μA, I _E = 0
Collector-Emitter Breakdown Voltage (Note 5)	BV _{CEO}	-12	-20	—	V	I _C = -10mA, I _B = 0
Emitter-Base Breakdown Voltage	BV _{EBO}	-5	-8.3	—	V	I _E = -100μA, I _C = 0
Collector Cutoff Current	I _{CBO}	—	-1	-100	nA	V _{CB} = -12V, I _E = 0
Collector Cutoff Current	I _{CES}	—	-1	-100	nA	V _{CE} = -12V, V _{BE} = 0
Emitter Cutoff Current	I _{EBO}	—	-1	-100	nA	V _{EB} = -5V, I _C = 0
ON CHARACTERISTICS						
DC Current Gain (Note 5)	h _{FE}	100 100 100	175 165 160	— 300 —	V	V _{CE} = -1.5V, I _C = -0.5A V _{CE} = -1.5V, I _C = -0.8A V _{CE} = -1.5V, I _C = -1A
Collector-Emitter Saturation Voltage (Note 5)	V _{CE(sat)}	— — —	-70 -95 -115	-160 -235 -290	mV	I _C = -0.5A, I _B = -10mA I _C = -0.8A, I _B = -16mA I _C = -1A, I _B = -20mA
Collector-Emitter Saturation Resistance	R _{CE(sat)}	—	—	290	mΩ	I _C = -1A, I _B = -20mA
Base-Emitter Saturation Voltage	V _{BE(sat)}	—	—	-0.95	V	I _C = -1A, I _B = -20mA
Base-Emitter Turn On Voltage	V _{BE(on)}	—	—	-0.95	V	V _{CE} = -1.5V, I _C = -1A
Output Capacitance	C _{obo}	—	—	65	pF	V _{CB} = -1.5V, f = 1.0MHz
Current Gain-Bandwidth Product	f _T	—	180	—	MHz	V _{CE} = -5V, I _C = -100mA, f = 100MHz

Notes: 5. Measured under pulsed conditions. Pulse width = 300μs. Duty cycle ≤2%.

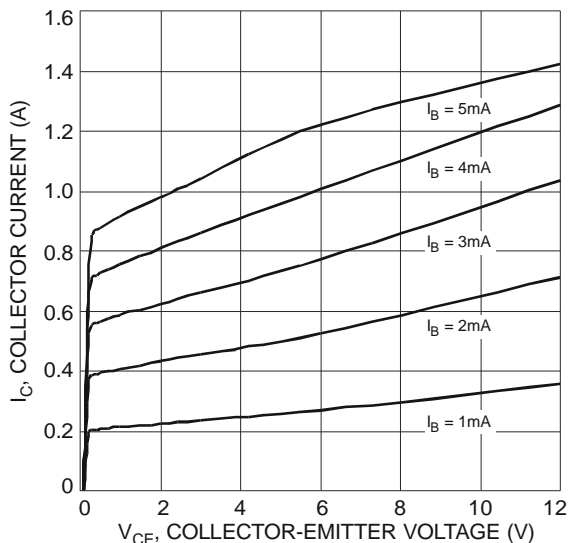


Fig. 4 Typical Collector Current vs. Collector-Emitter Voltage

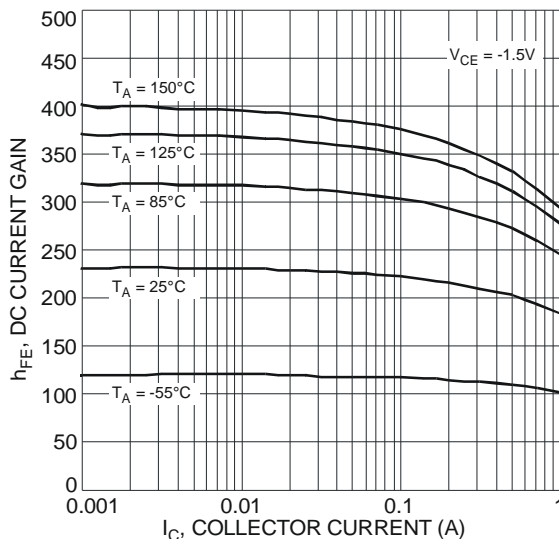


Fig. 5 Typical DC Current Gain vs. Collector Current

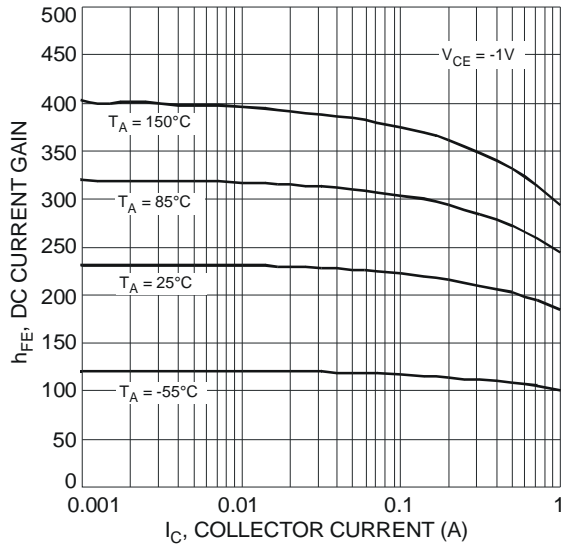


Fig. 6 Typical DC Current Gain vs. Collector Current

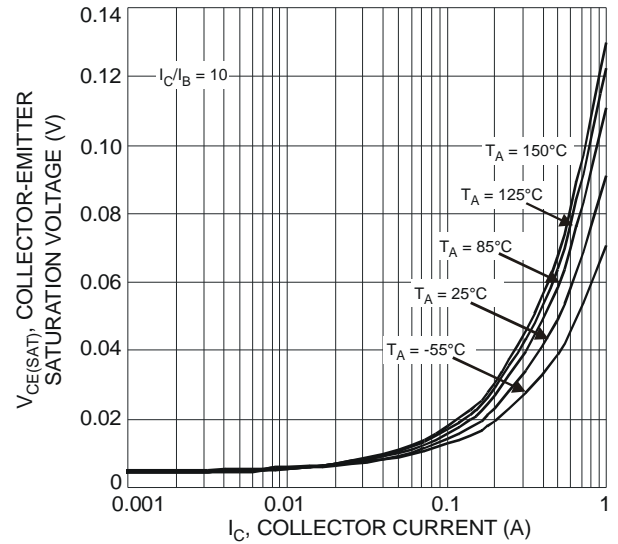


Fig. 7 Typical Collector-Emitter Saturation Voltage vs. Collector Current

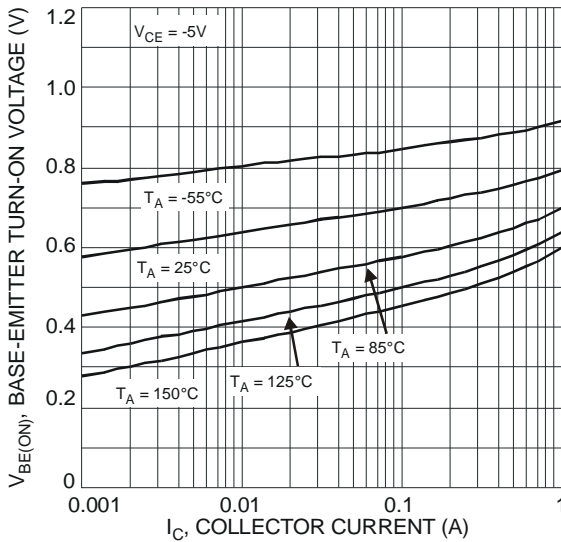


Fig. 8 Typical Base-Emitter Turn-On Voltage vs. Collector Current

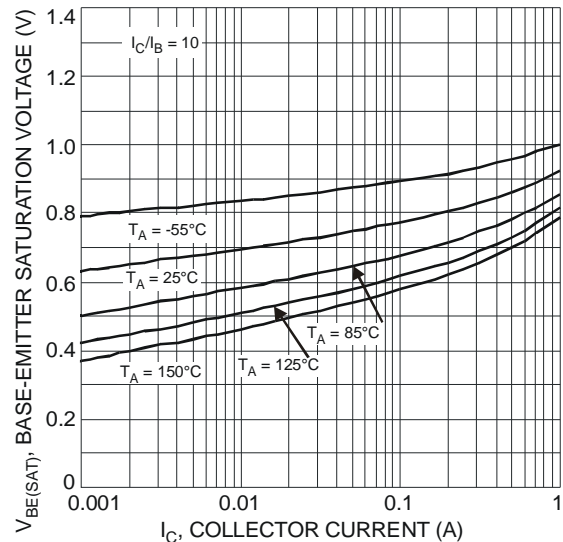


Fig. 9 Typical Base-Emitter Saturation Voltage vs. Collector Current

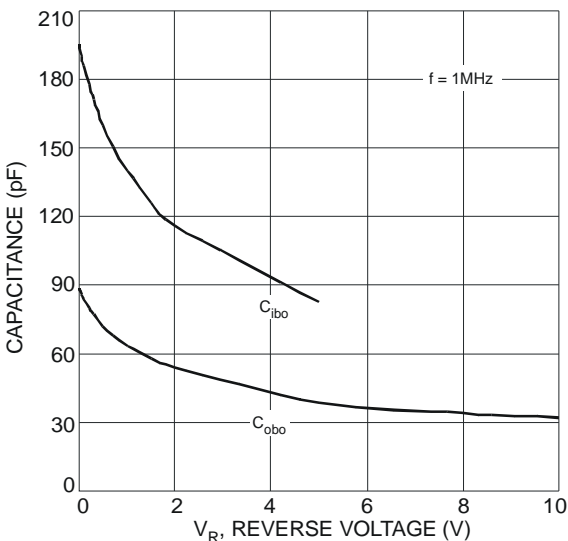
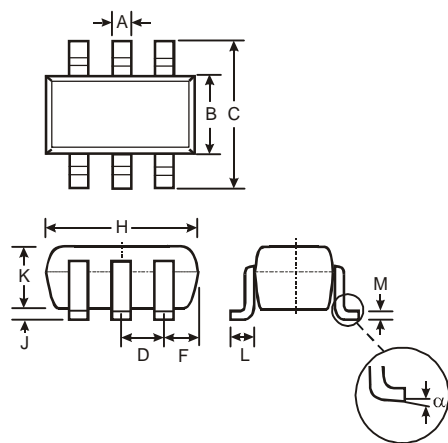


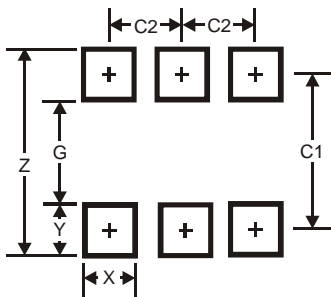
Fig. 10 Typical Capacitance Characteristics

Package Outline Dimensions



SOT-363		
Dim	Min	Max
A	0.10	0.30
B	1.15	1.35
C	2.00	2.20
D	0.65 Typ	
F	0.40	0.45
H	1.80	2.20
J	0	0.10
K	0.90	1.00
L	0.25	0.40
M	0.10	0.22
α	0°	8°
All Dimensions in mm		

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.5
G	1.3
X	0.42
Y	0.6
C1	1.9
C2	0.65

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